

Product Summary

BV _{DSS}	BV _{DSS} @T _{Jmax}	R _{DS(ON)} Max	I _D Max T _A = +25°C
115V	120V	90mΩ @ V _{GS} = 10V	3.4A
		100mΩ @ V _{GS} = 4.5V	2.3A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, which makes it ideal for high-efficiency power management applications.

Applications

- DC-DC Primary Switch
- Load Switch

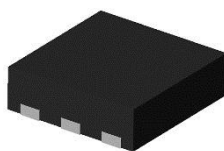
Features and Benefits

- 0.4mm Profile—Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- 100% Unclamped Inductive Switching (UIS) Test in Production—Ensures More Reliable and Robust End Application
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. “Green” Device (Note 3)**
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](mailto:contact_us@diodes.com) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>

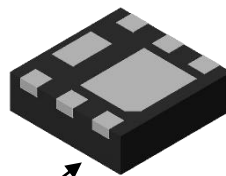
Mechanical Data

- Case: X2-DFN2020-6
- Case Material: Molded Plastic, “Green” Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish—NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.006 grams (Approximate)

X2-DFN2020-6 (Type W)

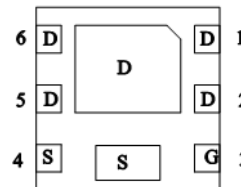


Top View

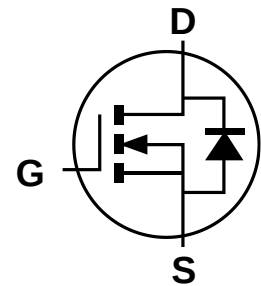


Pin1

Bottom View



Pin Out
Bottom View



Equivalent Circuit

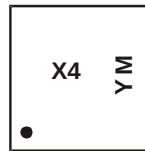
Ordering Information (Note 4)

Part Number	Case	Quantity Per Reel
DMT12H090LFDF4-7	X2-DFN2020-6 (Type W)	3,000
DMT12H090LFDF4-13	X2-DFN2020-6 (Type W)	10,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, “Green” and Lead-free.
 3. Halogen- and Antimony-free “Green” products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information

Site 1:



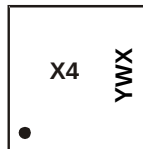
X4 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: I = 2021)
 M = Month (ex: 9 = September)

Date Code Key

Year	2018	...	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	F	...	I	J	K	L	M	N	O	P	R	S

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Site 2:



X4 = Product Type Marking Code
 YWX = Date Code Marking
 Y = Year (ex: 1 = 2021)
 W = Week (ex: a = Week 27; z Represents Week 52 and 53)
 X = Internal Code (ex: U = Monday)

Date Code Key

Year	2018	...	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	8	...	1	2	3	4	5	6	7	8	9	0

Week	1-26	27-52	53
Code	A-Z	a-z	z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	T	U	V	W	X	Y	Z

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	115	V
Gate-Source Voltage	V _{GSS}	±12	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	I _D	3.4 2.7	A
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)	I _{DM}	15	A
Maximum Body Diode Continuous Current (Note 6)	I _S	3.4	A
Pulsed Body Diode Continuous Current (10μs Pulse, Duty Cycle = 1%)	I _{SM}	15	A
Avalanche Current, L = 0.3mH	I _{AS}	2.3	A
Avalanche Energy, L = 0.3mH	E _{AS}	0.79	mJ

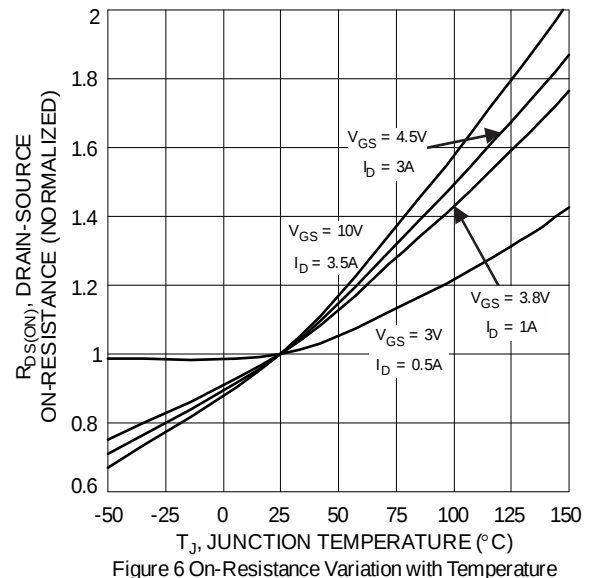
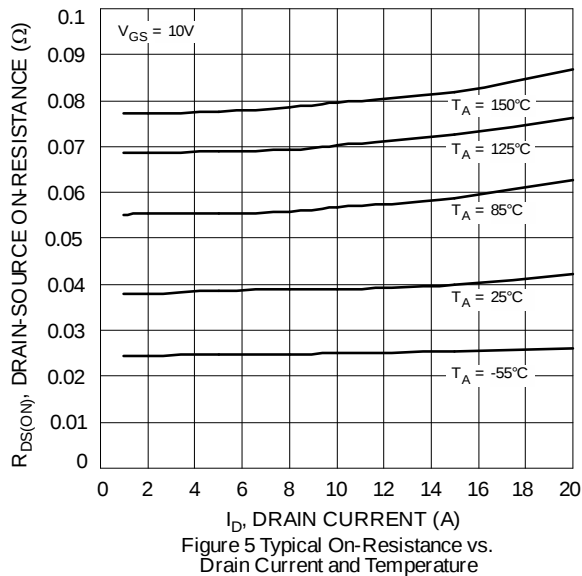
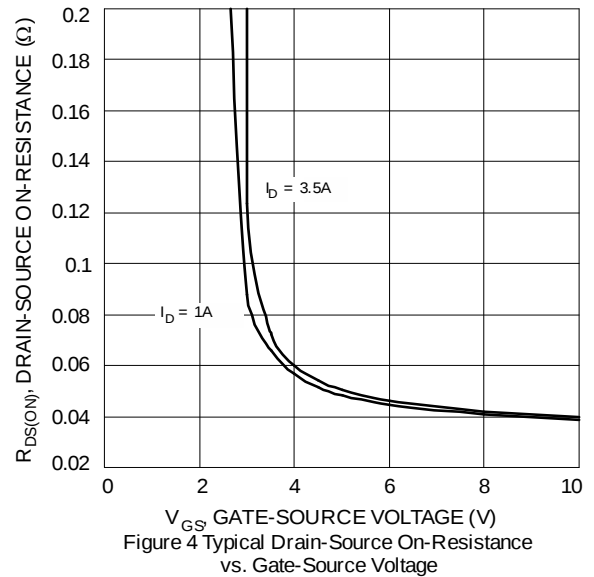
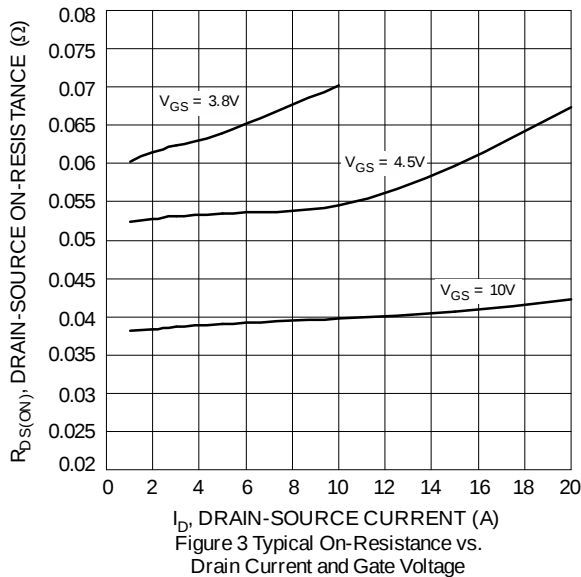
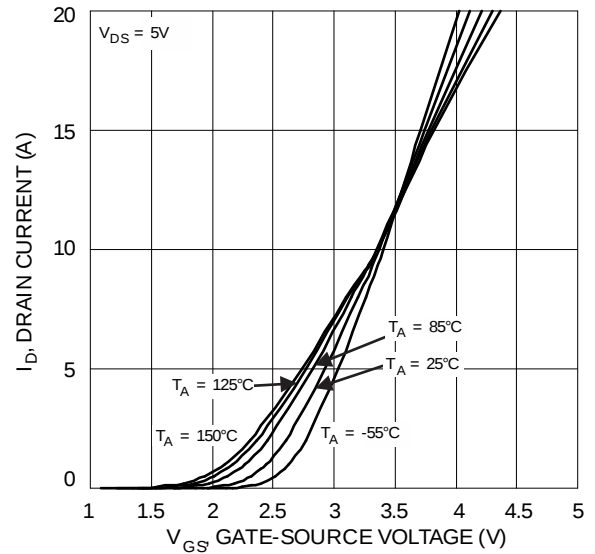
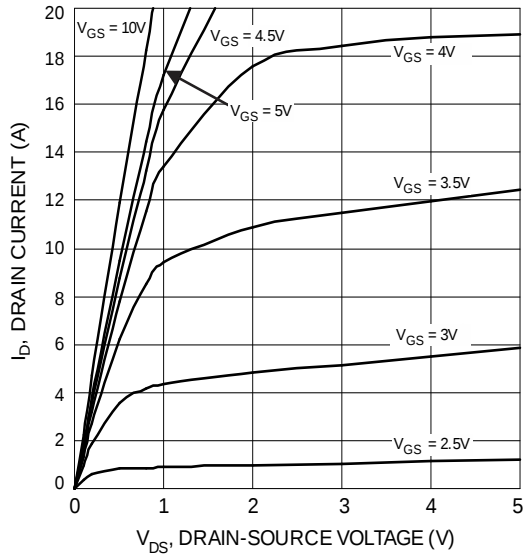
Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P _D	0.9 0.6	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	141	°C/W
Total Power Dissipation (Note 6)	P _D	1.6 1.0	W
Thermal Resistance, Junction to Ambient (Note 6)	R _{θJA}	78	°C/W
Thermal Resistance, Junction to Case (Note 6)	R _{θJC}	15	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	115	—	—	V	V _{GS} = 0V, I _D = 10mA
Zero Gate Voltage Drain Current	I _{DSS}	—	—	1	μA	V _{DS} = 92V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	V _{GS} = ±9.6V, V _{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.6	—	2.2	V	V _{DS} = V _{GS} , I _D = 250μA
Static Drain-Source On-Resistance	R _{DS(ON)}	—	—	90	mΩ	V _{GS} = 10V, I _D = 3.5A
		—	—	100		V _{GS} = 4.5V, I _D = 3.0A
		—	—	300		V _{GS} = 3.8V, I _D = 1.0A
		—	—	350		V _{GS} = 3V, I _D = 0.5A
		—	—	—		V _{GS} = 0V, I _S = 2.4A
Diode Forward Voltage	V _{SD}	—	—	1.3	V	V _{GS} = 0V, I _S = 2.4A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	—	251	—	pF	V _{DS} = 50V, V _{GS} = 0V, f = 1MHz
Output Capacitance	C _{oss}	—	80	—	pF	
Reverse Transfer Capacitance	C _{rss}	—	3	—	pF	
Gate Resistance	R _g	—	7	—	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz
Total Gate Charge	Q _g	—	6	—	nC	V _{DS} = 50V, I _D = 4.5A, V _{GS} = 10V
Gate-Source Charge	Q _{gs}	—	0.3	—	nC	
Gate-Drain Charge	Q _{gd}	—	2	—	nC	
Turn-On Delay Time	t _{D(ON)}	—	2.2	—	ns	V _{DS} = 50V, R _L = 11Ω V _{GS} = 10V, R _{GEN} = 3Ω
Turn-On Rise Time	t _r	—	2.6	—	ns	
Turn-Off Delay Time	t _{D(OFF)}	—	9.3	—	ns	
Turn-Off Fall Time	t _f	—	3.9	—	ns	I _F = 4.5A, di/dt = 300A/μs
Reverse Recovery Time	t _{rr}	—	83	—	ns	
Reverse Recovery Charge	Q _{rr}	—	189	—	nC	

- Notes:
- Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
 - Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.
 - Short duration pulse test used to minimize self-heating effect.
 - Guaranteed by design. Not subject to product testing.



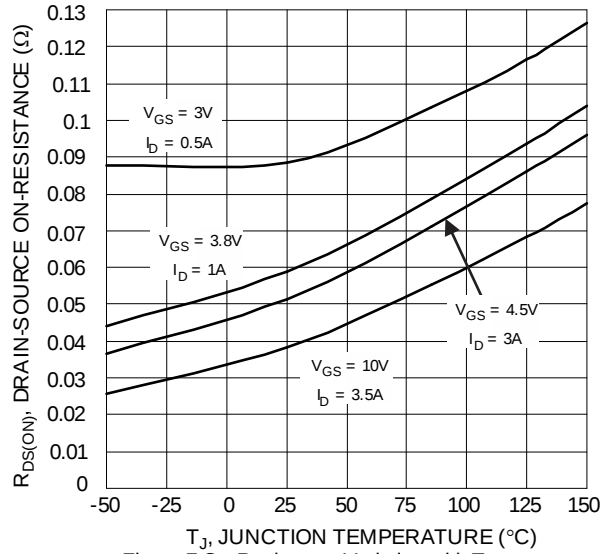


Figure 7 On-Resistance Variation with Temperature

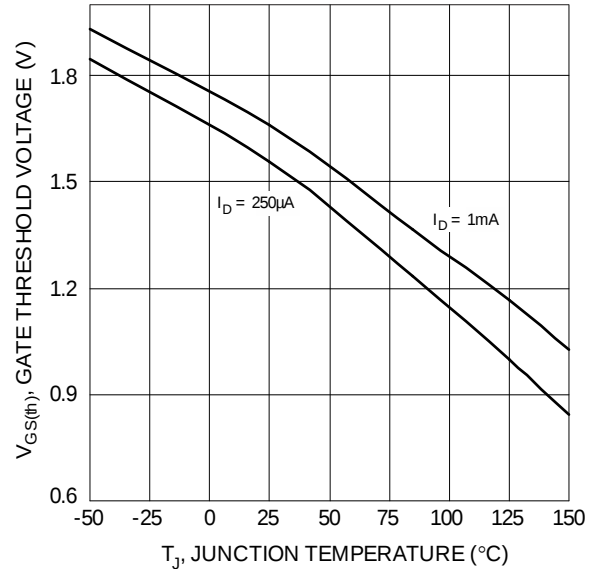


Figure 8 Gate Threshold Variation vs. Junction Temperature

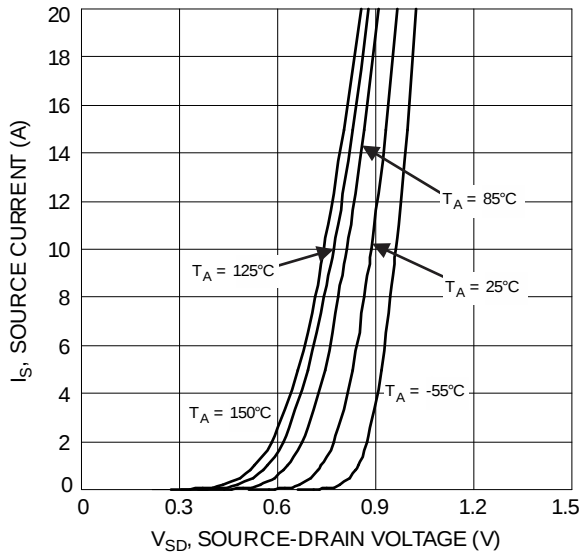


Figure 9 Diode Forward Voltage vs. Current

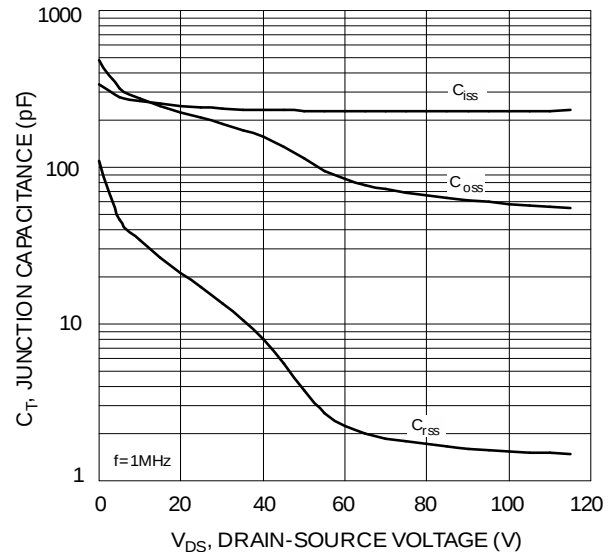


Figure 10 Typical Junction Capacitance

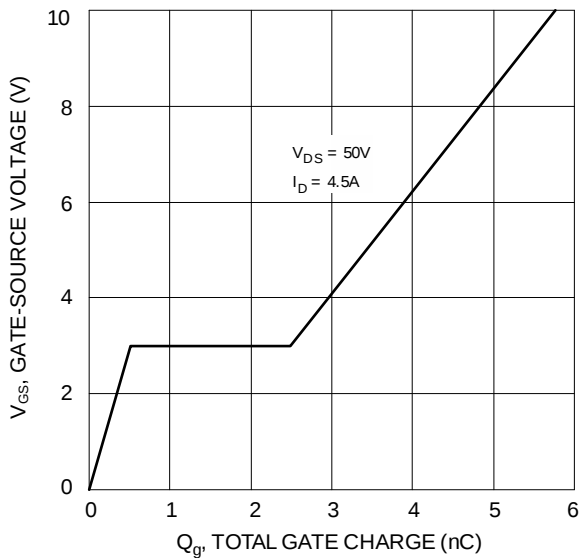


Figure 11 Gate Charge

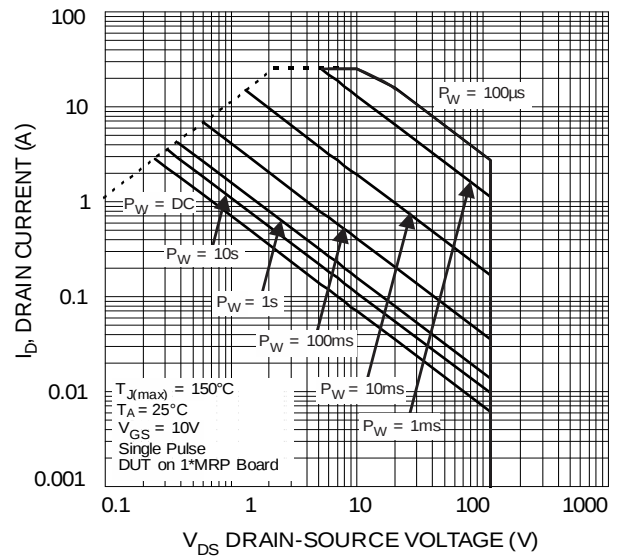
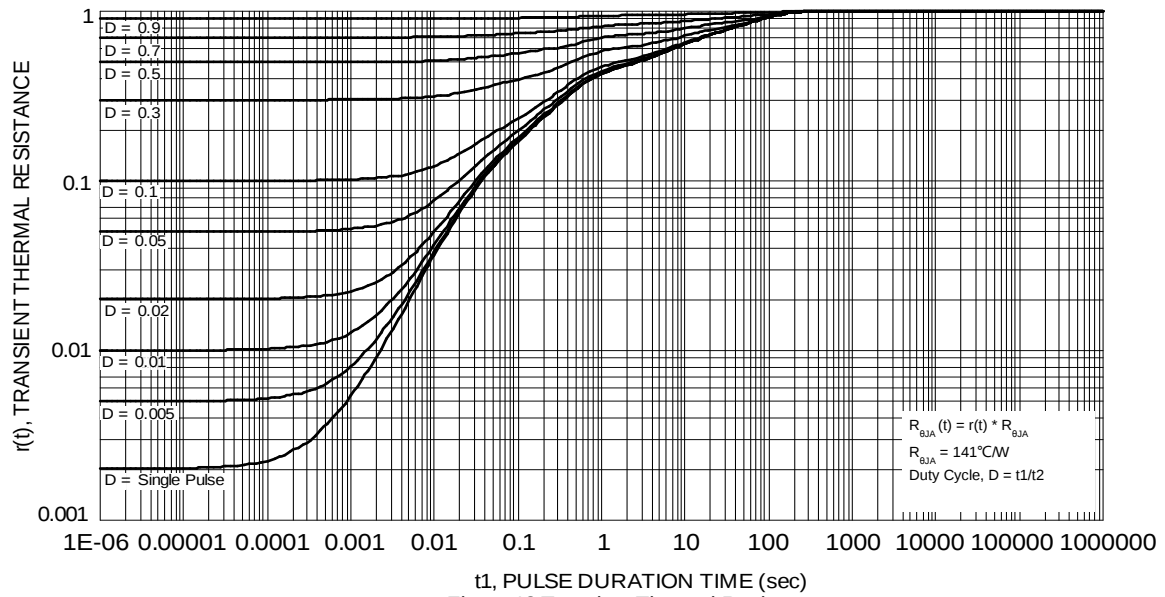


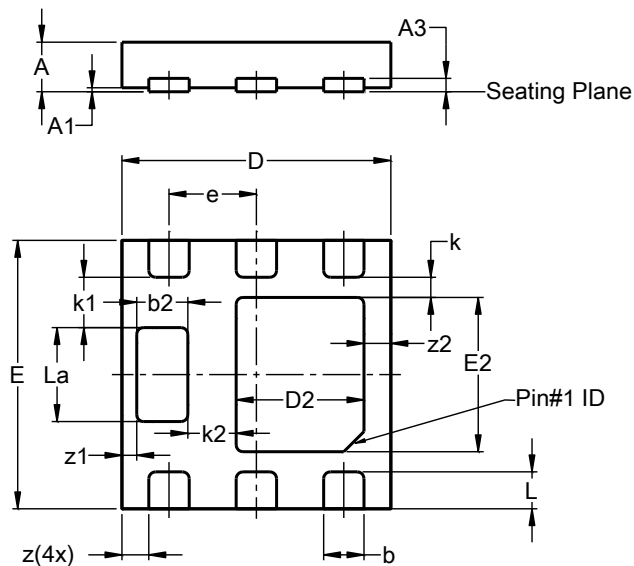
Figure 12 SOA, Safe Operation Area



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X2-DFN2020-6 (Type W)

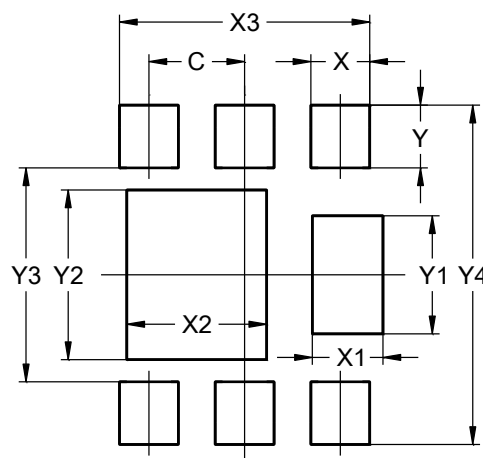


X2-DFN2020-6 Type W			
Dim	Min	Max	Typ
A	0.34	0.40	0.37
A1	0.00	0.05	0.02
A3	—	—	0.100
b	0.25	0.35	0.30
b2	0.33	0.43	0.38
D	1.95	2.05	2.00
D2	0.85	1.05	0.95
E	1.95	2.05	2.00
E2	1.05	1.25	1.15
e	—	—	0.65
k	—	—	0.15
k1	—	—	0.375
k2	—	—	0.36
L	0.225	0.325	0.275
La	0.65	0.75	0.70
z	—	—	0.20
z1	—	—	0.11
z2	—	—	0.20
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X2-DFN2020-6 (Type W)



Dimensions	Value (in mm)
C	0.650
X	0.400
X1	0.480
X2	0.950
X3	1.700
Y	0.425
Y1	0.800
Y2	1.150
Y3	1.450
Y4	2.300

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